

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
(Case No. 207.010-US)

In the Application of: **LUTZ ET AL.**

Serial No: **10/698,258**

Filed: **OCTOBER 3, 2003**

Title: **ANTI-STICTION TECHNIQUE FOR THIN FILM
AND WAFER-BONDED ENCAPSULATED
MICROELECTROMECHANICAL SYSTEMS**

) Group
) Art Unit: **2814**
)
) Before
) Examiner: **Le, Dung Anh**
)

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Commissioner for Patents
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Michiko Sites
(name of person signing certificate)

Michiko Sites
Signature

AMENDMENT AND REPLY OF NOVEMBER 16, 2004

Dear Sir:

Kindly amend the application as follows: